termPIR® Insulation boards

TECHNICAL CARD termPIR® AL GK INSULATION BOARDS



termPIR® AL GK	Product details:
Description of board:	termPIR® AL GK composite insulation boards are composed of a termPIR® boards with a PIR foam core covered on both sides by gas-rasistant paper- and aluminium-based facings, and gypsum board with thickness od 12,5 mm. An adhesive layer bonds the paper- and aluminium-based facing and the gypsum board.

Certificates / Approvals:			
CE mark			
ISO 9001, ISO 14001 System certificates		arch	Green nitecture
Compatibility with EN 13950			
Environmental Declaration EPD (type III)			
Environmental Certificate (type III)	-		
CO2 footprint			
(Leed & Breeam) Green Card			
Atest PZH			
VOC			
Keymark certificate and quality label			
Tests of thermal properties ITB			
Fire classifications			
Board in the product base SVT			
Board in the product base EPDM			
SundaHUS			
BVB	FIT (flat milling)	LAP (stepwise milling)*	TAG (tongue and
Swan- The Nordic Ecolabel	Til (liat lillillig)	LAP (stepwise Hilling)	groove)*
Certificate for the system ETICS	* dimensions of boards	s with joint types are 2 to 4 %	smaller
Admitted to trading in the EU			

Information about product safety:	Information about suabstances contained in the product referred to in Art. 31 and 33 of the Regulation (CE) No.1907/2006 (REACH): Not applicable.
Instruction:	Boards can be installed in one or multiple layers in an interlocking manner. Boards should fit tightly to each other. The substructure needs to be stable. Install mechanically with fasteners, glue or suspend - depending on the kind of substructure and type of waterproofing. Prevent from pulling the fasteners through the board. Secure against the impact of weather conditions. The boards are not load-bearing elements Additional information is available in the Technical Catalogue at the website www.termpir.eu

www.termpir.eu

termPIR® Insulation boards

TECHNICAL CARD termPIR® AL GK INSULATION BOARDS



termPIR® A	71 CK		Produc	t details:						
terrir r	AL OR		riodac	t details.						
Declared heat transfer coefficient for d _N * = 25 mm /+ 12,5 mm:		(20 ≤ d,	$(20 \le d_N \le 250 \text{ mm}): \lambda_D = 0.022 \text{ (W/m-K)}$							
Thermal re	sistance R _D 5 mm /+ 12,5	mm:	1,15 [W	1,15 [W/m·K]						
Declared heat transfer coefficient for d _N * = 20 mm /+ 12,5 mm:		(20 ≤ d _s	$(20 \le d_N \le 250 \text{ mm}); \lambda_D = 0.022 \text{ (W/m-K)}$							
Standard k	ooard dimen	sions [mm]:	2600 m	nm (±10 m	m)/1200	m (±7,5 m	m)			
	Coefficient U = 1 / (Re	:: U [W/m²-K], wg + R _D + Ri)								
For a giver	n nominal	for wall	20	0,93	30	0,66	40	0,50	50	0,40
thickness Thermal re	[mm]:	or roof	0,90	0,96	1,35	0,67	1,85	0,50	2,30	0,41
$R_{_D}$ [m ² ·K/W	/]	for floor		0,93		0,66		0,50		0,40
		60	0,34	70	0,29	80	0,26	90	0,23	
			2,75	0,35	3,25	0,29	3,70	0,26	4,15	0,23
				0,34		0,29		0,26		0,23
			100	0,21	110	0,19	120	0,17	130	0,16
			4,65	0,21	5,10	0,19	5,55	0,18	6,05	0,16
				0,21		0,19		0,17		0,16
			140	0,15	150	0,14	160	0,13	-	-
			6,50	0,15	6,95	0,14	7,45	0,13	-	-
				0,15		0,14		0,13		
Reaction to	o fire (end of l:	use)	B-s1,d0 Class "non-fire spreading product" Applies to termPIR ® AL GK boards with PIR layer 20-140 mm thick + 12.5 mm gypsum board. Substrate: the boards can be used on any non-combus ble or wood effect substrate. They are attached to structures using an adhesive (including combustible adhesives), termPIR boards can also be attached mechanically. For details please see the classification.			combusti- an adhe-				

www.termpir.eu _____

^{*} for d = 20 - 250 mm /+12 mm. The thermal characteristics pertain to a PIR insulation core together with facings.

The calculations did not take into account the thermal resistance of the gypsum board or the resistance of the adhesive layer.

termPIR® Insulation boards

TECHNICAL CARD termPIR® AL GK INSULATION BOARDS



termPIR® AL GK	Parameters of termPIR® board with aluminum cladding
PIR core density:	30 kg/m³
Reaction to fire:	B-s1;d0

CK board	Parameters of the GK board (based on the manufacturer's declaration)			
Reaction to fire:	A2-s1,d0			
Coecient of thermal conductivity (for thickness of 12.5 mm):	0,25 [W/m·K]			

Buildings:	Intended use of the board:
residential, high density housing	on rafter insulation system on pitched roofs
residential	under rafter insulation system on pitched roof
residential, retail and industrial	build Up Roofs [BUR] - Flat roofs, mechanically fastened
residential, retail and industrial	build Up Roofs [BUR] - Flat roofs,adhesive or glued systems
residential, retail and industrial	triple layered external walls - cavity walls
residential, retail and industrial	double layered external walls - ETICS system
residential, retail and industrial	basement and foundation walls
residential, retail and industrial	partition walls
residential, retail and industrial	slabs between floors
residential, retail and industrial	ground floor slabs
livestock, industrial	suspended ceilings - high pressure washable
existing, historic, stair-cores	internal wall insulation
prefabricated concrete walls	highly resistant to corrossion caused by concrete
the board recommended for use boards	that can be used

DoP Nr termPIR / GP / 1 / GK / 2 Update: 0302.2025

---- www.termpir.eu ------

ww.termpir.eu			